



**THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Bernd Borchert  
Serial No.: 09/944,823  
Filed: August 31, 2001  
For: SEMICONDUCTOR LASER CHIP AND METHOD FOR  
FABRICATING A SEMICONDUCTOR LASER CHIP  
Confirmation No.: 3378  
Group Art Unit: 2828  
Examiner: Delma R. Flores Ruiz  
Attorney Docket No.: 32226.12

Additional Fees: Charge to Deposit Account 023732

Mail Stop Non-Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir or Madam:

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MAR 09 2004

**AMENDMENT AND RESPONSE**

This paper is being filed in response to the Office Action mailed December 3, 2003.  
Please amend the above-identified application as follows:

**CERTIFICATE OF MAILING**

I hereby certify that this document is being deposited with the United States Postal Service as First Class Mail, in an envelope addressed to Mail Stop Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date indicated below.

By Ann Hestad  
Date 3/2/04